



**A COLLABORATIVE PATHWAY
TO NET ZERO**

Gary Dickerson

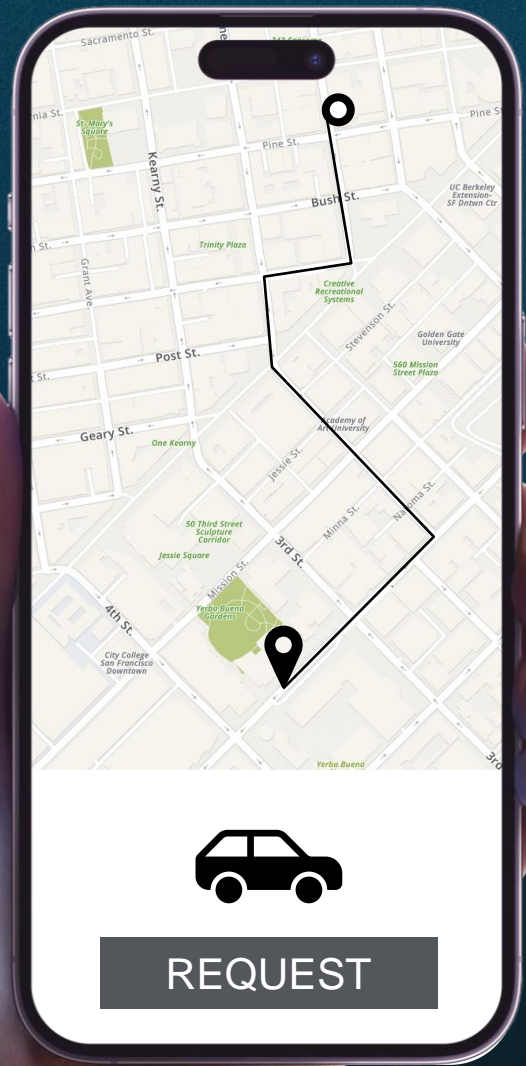
President and CEO, Applied Materials

SEMICON WEST 2023

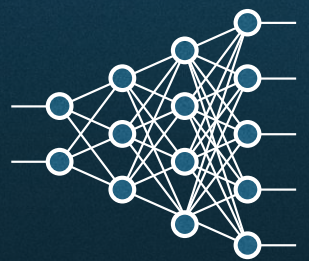
Forward-Looking Statements and Reporting Uncertainties

This presentation contains forward-looking statements, including our sustainability strategies and targets and other statements that are not historical facts. These statements, and their underlying assumptions and projections, are subject to risks and uncertainties, and are not guarantees of future performance. Factors that could cause actual results to differ materially from those expressed or implied by such statements include, without limitation: our and the industry's ability to achieve sustainability strategies and goals; failure to realize the anticipated benefits of planned investments and technology innovations related to sustainability; the level of demand for semiconductors and our products; customers' technology and capacity requirements; the introduction of new and innovative technologies, and the timing of technology transitions; our ability to develop, deliver and support new products and technologies; market acceptance of existing and newly developed products; and other risks and uncertainties included in the "Risk Factors" section of our SEC filings, including our recent Forms 10-Q and 8-K. All forward-looking statements are based on management's current estimates, projections and assumptions, and we assume no obligation to update them.

Non-financial information is subject to measurement uncertainties resulting from limitations inherent in the nature and methods used for determining such data. The selection of different but acceptable measurement techniques can result in materially different measurements.



same



AI

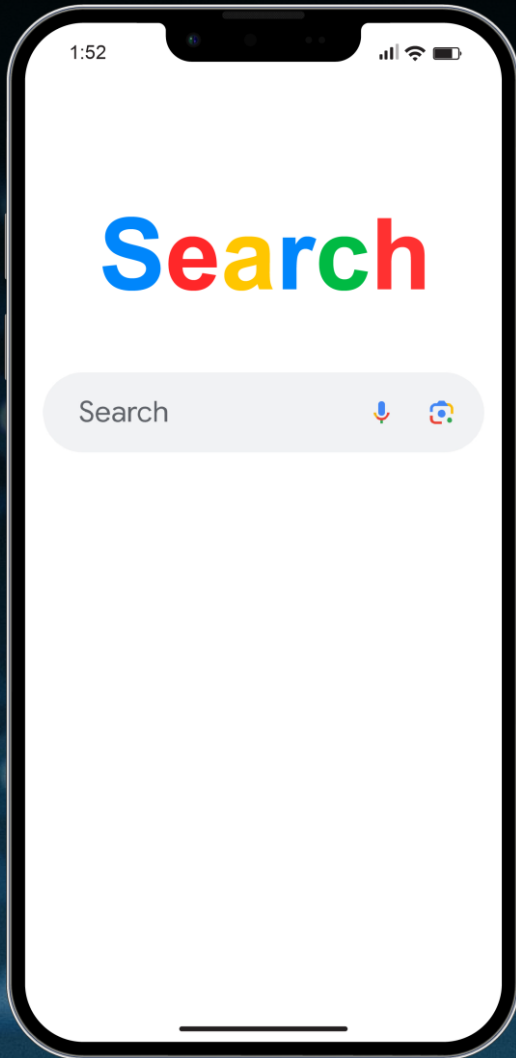
~2.4kWh



HUMAN

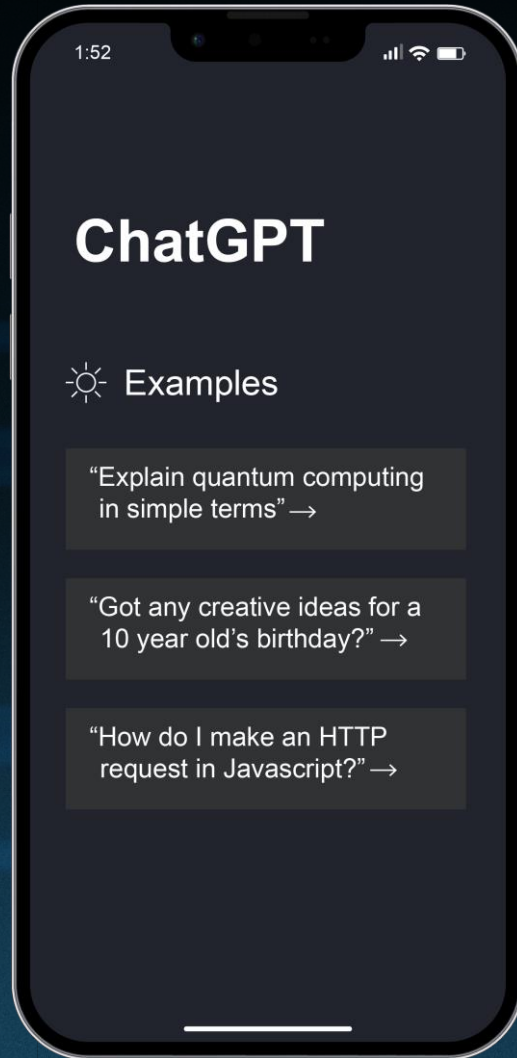
~3Wh

800x



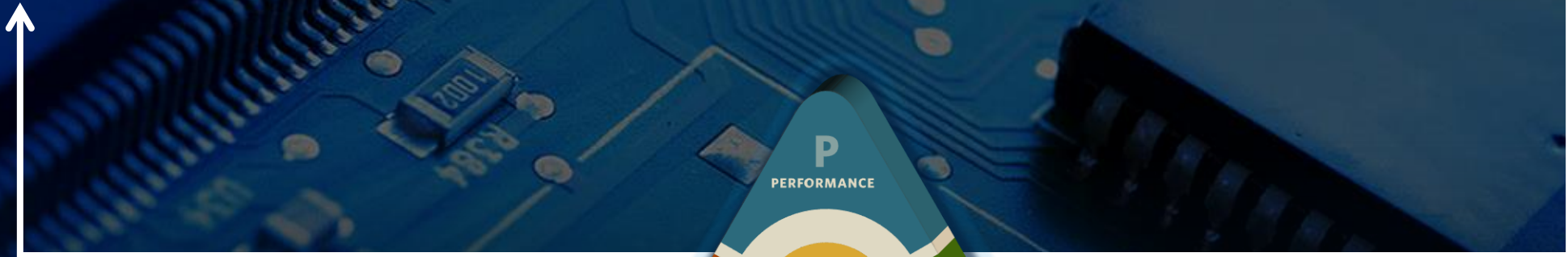
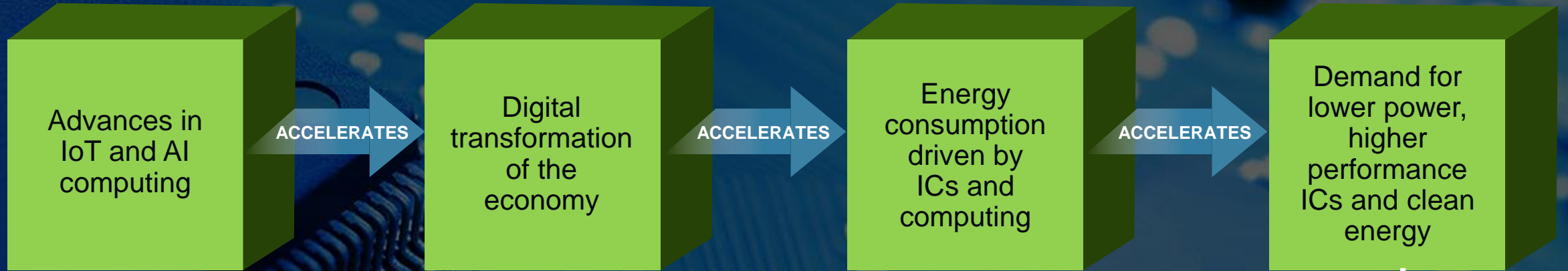
0.0003 kWh
standard Google search

vs.

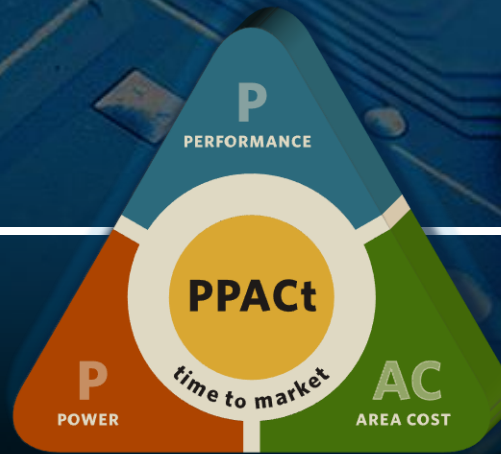


0.004 kWh

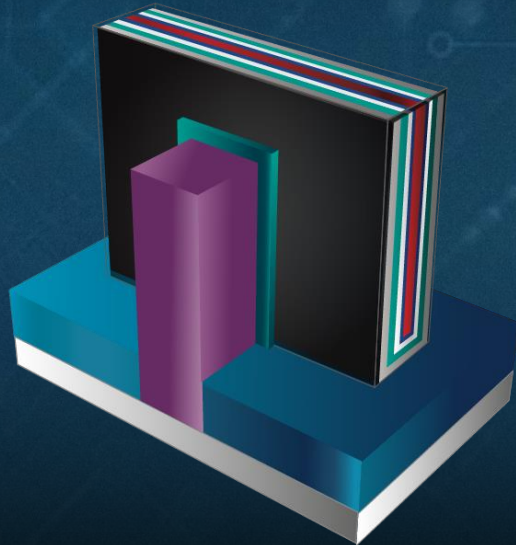
13x
energy consumption



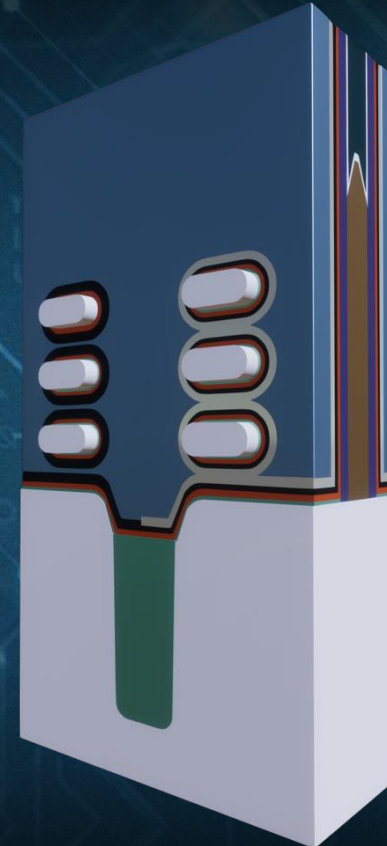
'ENERGY-EFFICIENT COMPUTING'



Energy-Efficient Computing enabled by **complexity**...



FinFET

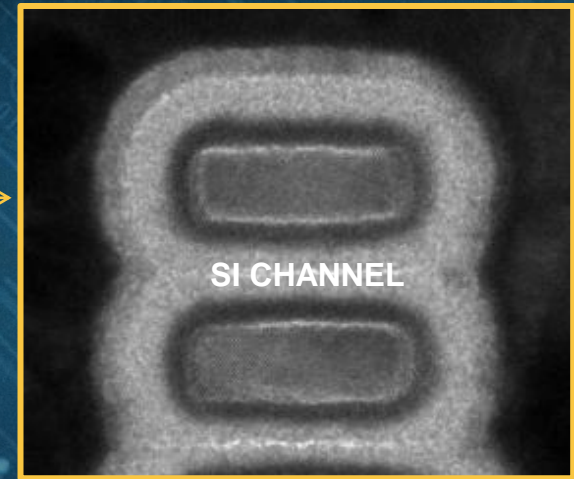
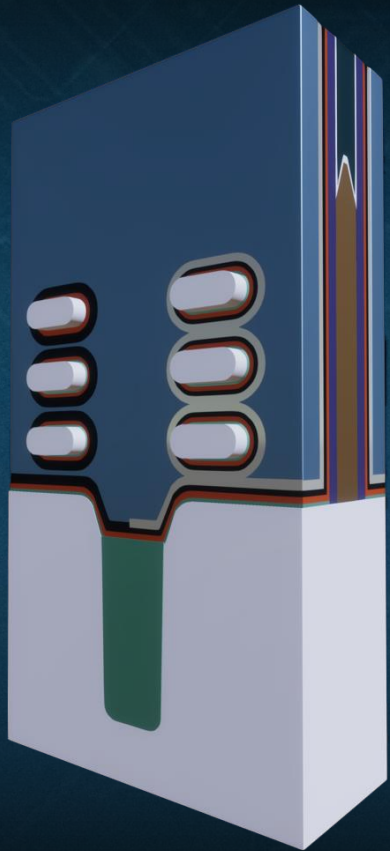


GAA

33% improvement
in energy efficiency*

* Source: TSMC

What complexity **really** looks like...



ENABLED BY
Atomic-level processing
Thinnest layer is 1nm

COMPREHENSIVE APPROACH TO ESG

NET ZERO PLAYBOOK
(focus for today)

Applied SCOPE 3

Applied SCOPE 1 and 2



1X

OUR OPERATIONS



100X

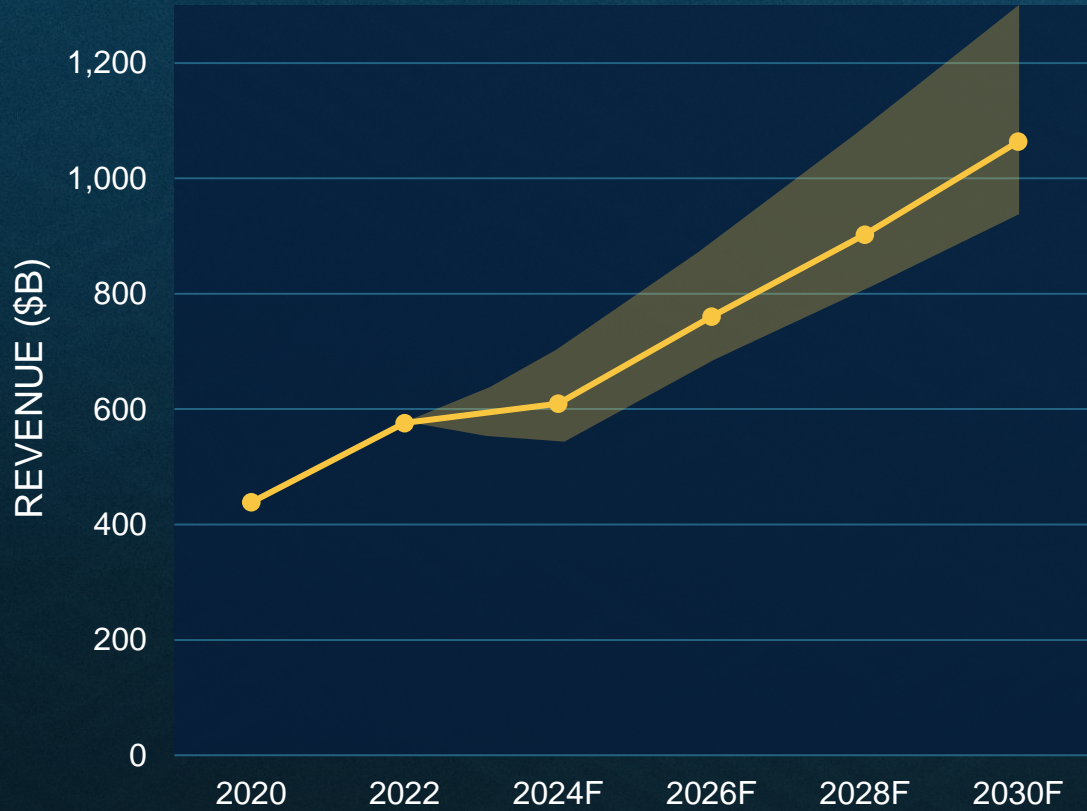
SEMI INDUSTRY OPERATIONS



10,000X

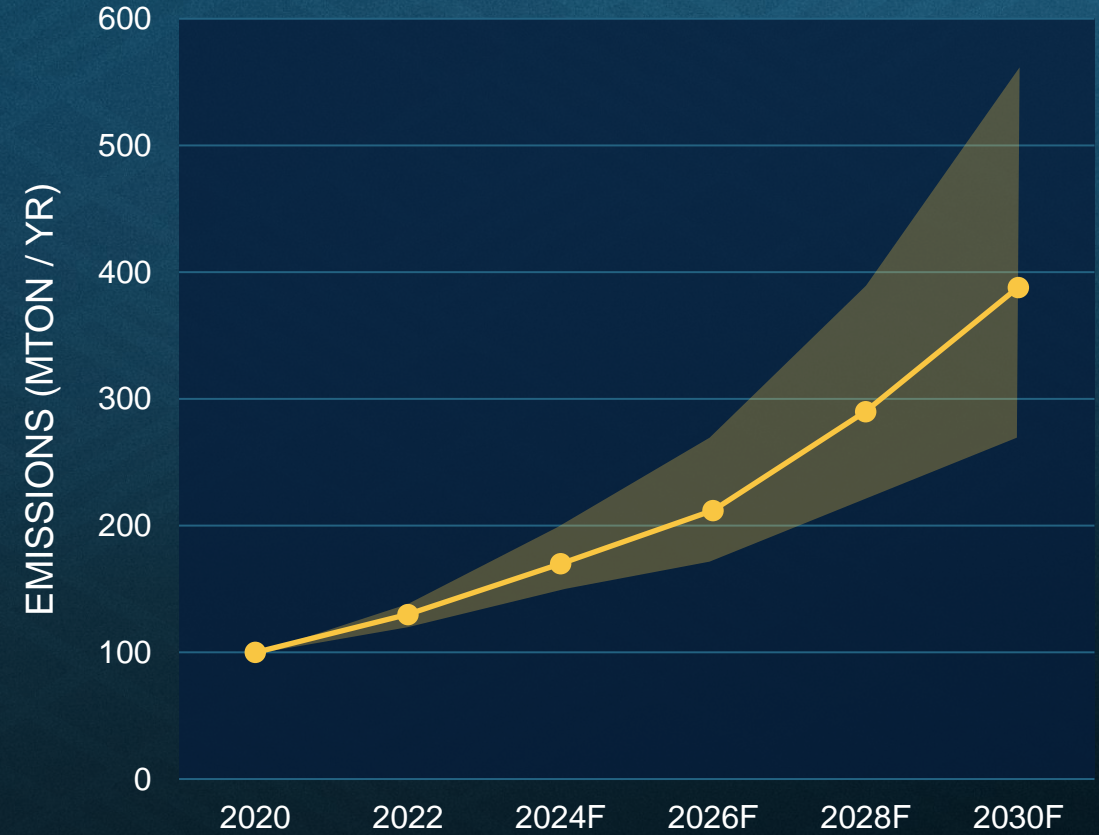
GLOBAL ELECTRONICS

Semiconductor Industry Revenues¹



>2x in 10 years

Semiconductor Manufacturing Carbon Emissions²



>4x in 10 years

Sources: 1) McKinsey and Company, SEMI, TechInsights, Applied Materials 2) imec

Applied's Greenhouse Gas Emissions

SCOPE 3 Product Use:

Downstream value chain emissions, tracked across 7 categories

SCOPE 3 Supply Chain:

Upstream value chain emissions, tracked across 8 categories

SCOPE 2:

Purchased electricity for our operations

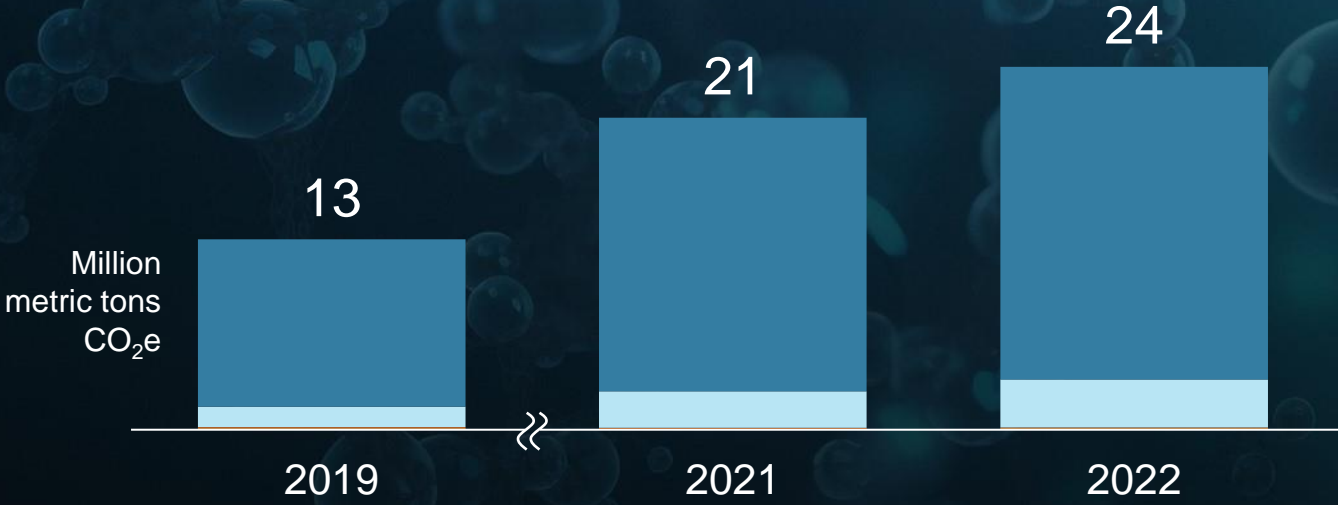
SCOPE 1:

Fuels used in our operations (natural gas, process gases)

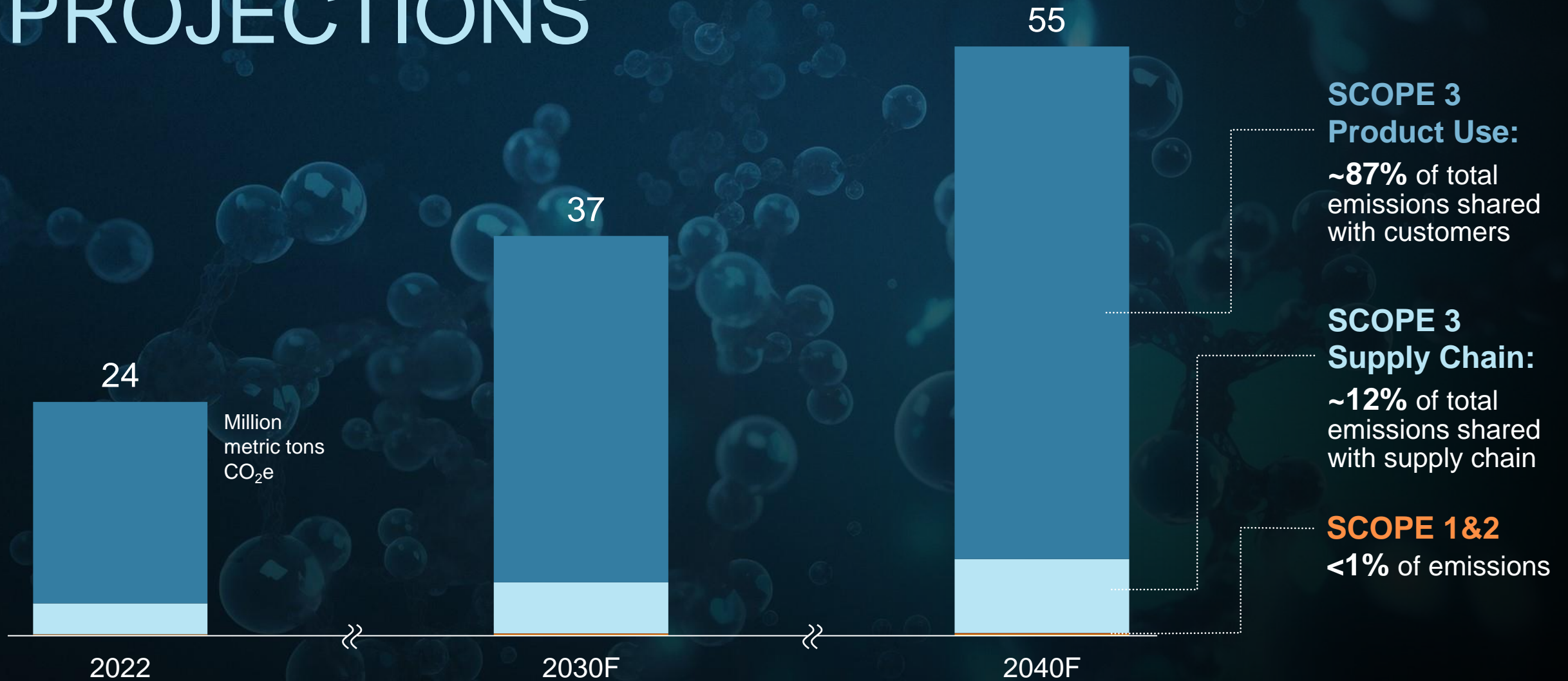


* Predominantly Category 1: purchased goods and services and Category 11: use of sold products. Other Scope 3 categories total ~5%

Applied's Greenhouse Gas Emissions ACTUALS

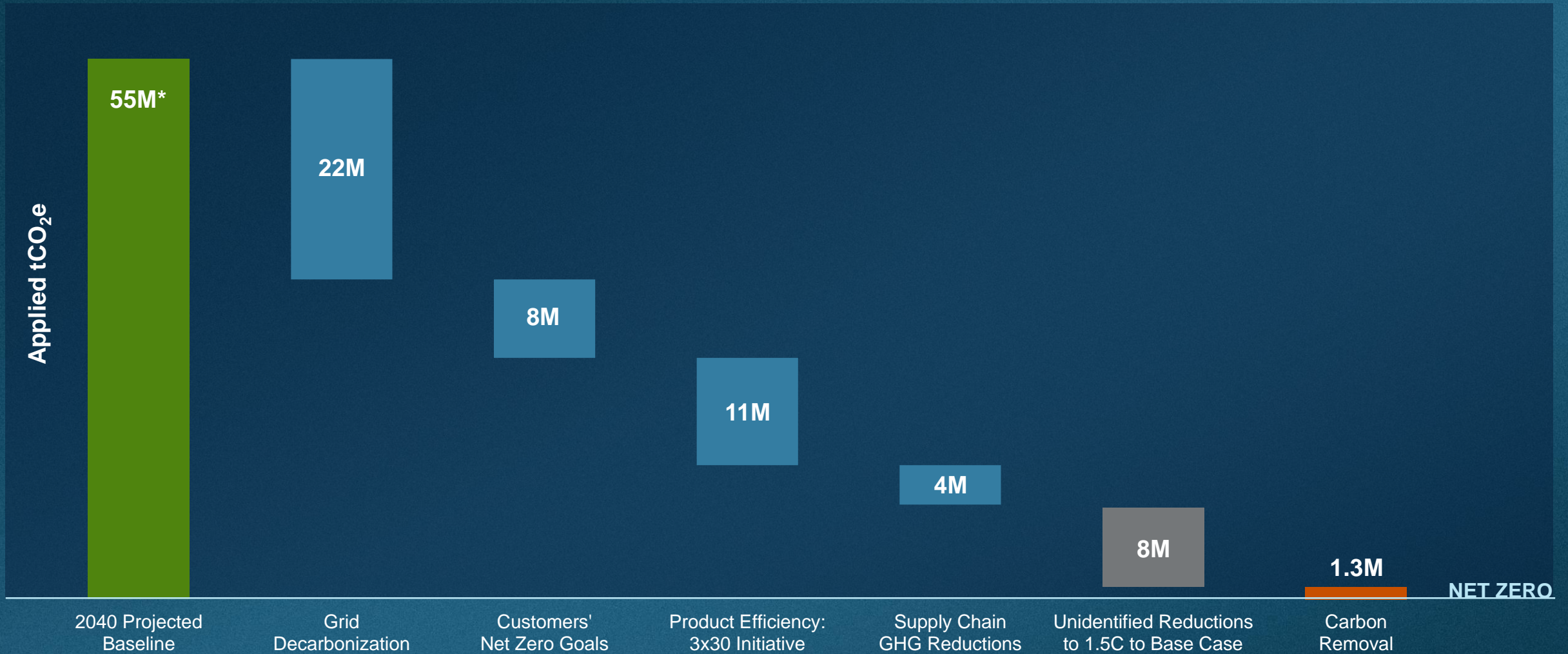


Applied's Greenhouse Gas Emissions PROJECTIONS



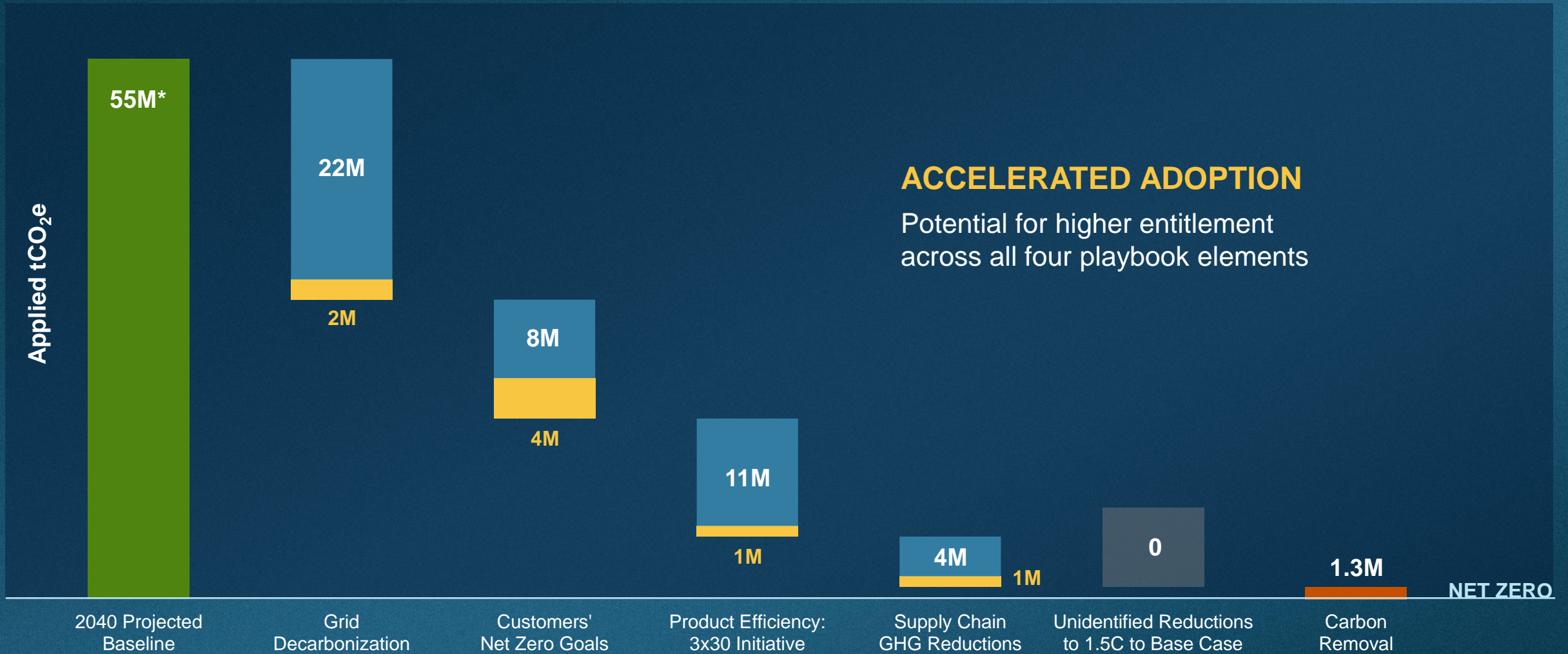
* Covers 90% of Applied's Scope 3 emissions per SBTi Net Zero standard

Applied's Net Zero Playbook – Base Case



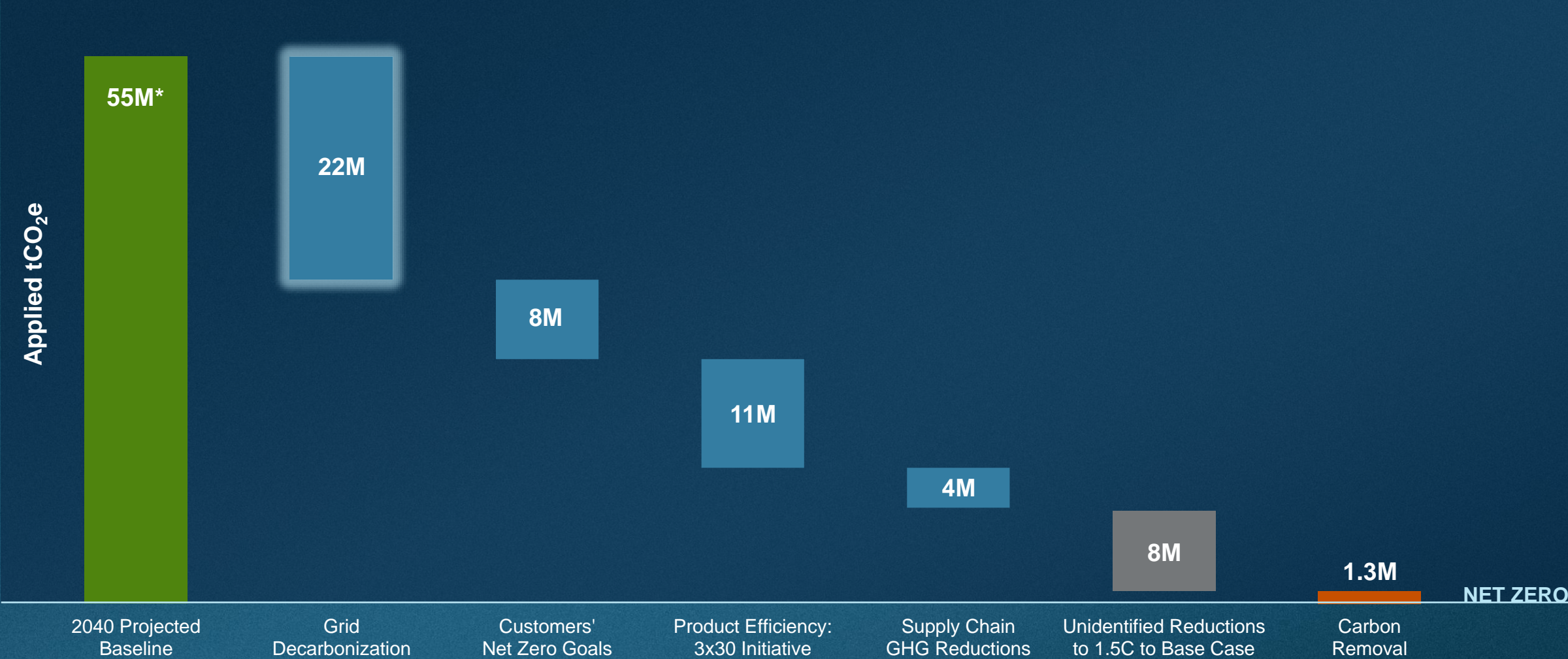
*Covers 90% of Applied's Scope 3 per SBTi (87% product use emissions; 13% supply chain). GHG = Greenhouse Gas

Applied's Net Zero Playbook – Accelerated Adoption



*Covers 90% of Applied's Scope 3 per SBTi (87% product use emissions; 13% supply chain). GHG = Greenhouse Gas

Applied's Net Zero Playbook – Base Case



*Covers 90% of Applied's Scope 3 per SBTi (87% product use emissions; 13% supply chain). GHG = Greenhouse Gas

Accelerate Grid Decarbonization and Efficiency

22M tCO₂e by Country*
(accelerated adoption >24M tCO₂e)



*Reduction size is driven by a combination of volume of systems by destination and projected rate of renewables in that region by 2040 (IEA)

CALL TO ACTION:

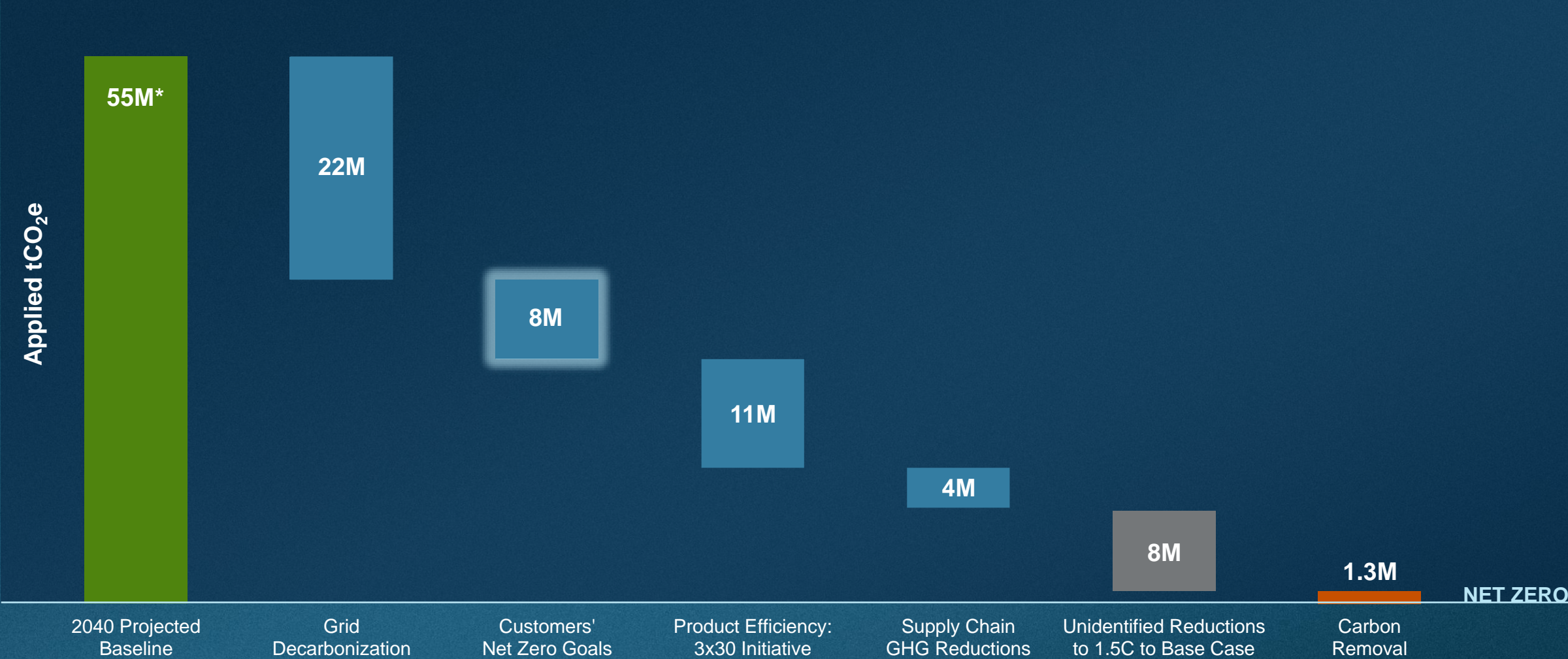
Amplify industry's combined voice as buyer of energy (increase entitlement)

Increase focus on proximity to clean energy as key factor in **fab location choice**

Help accelerate grid transformation (can drive up to \$50B of semi demand by 2030)



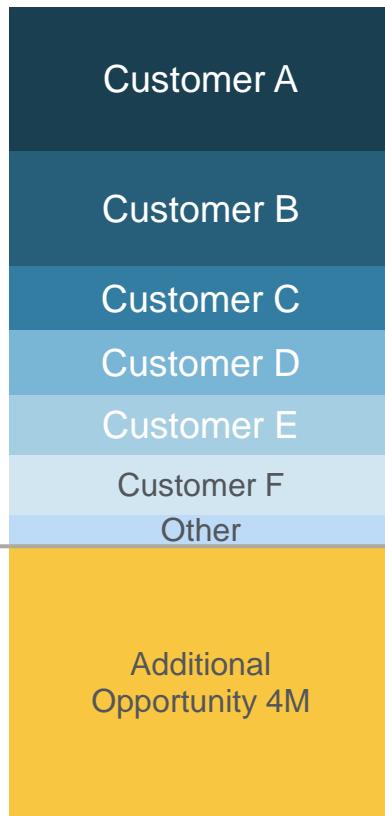
Applied's Net Zero Playbook – Base Case



*Covers 90% of Applied's Scope 3 per SBTi (87% product use emissions; 13% supply chain). GHG = Greenhouse Gas

Support and Expand Customers' Net Zero Goals

8M tCO₂e by Strategy*
(accelerated adoption >12M tCO₂e)



*Reductions from energy powering the fab, based on customers' publicly stated goals

~65% of current global IC production from chipmakers with Net Zero goals

CALL TO ACTION:

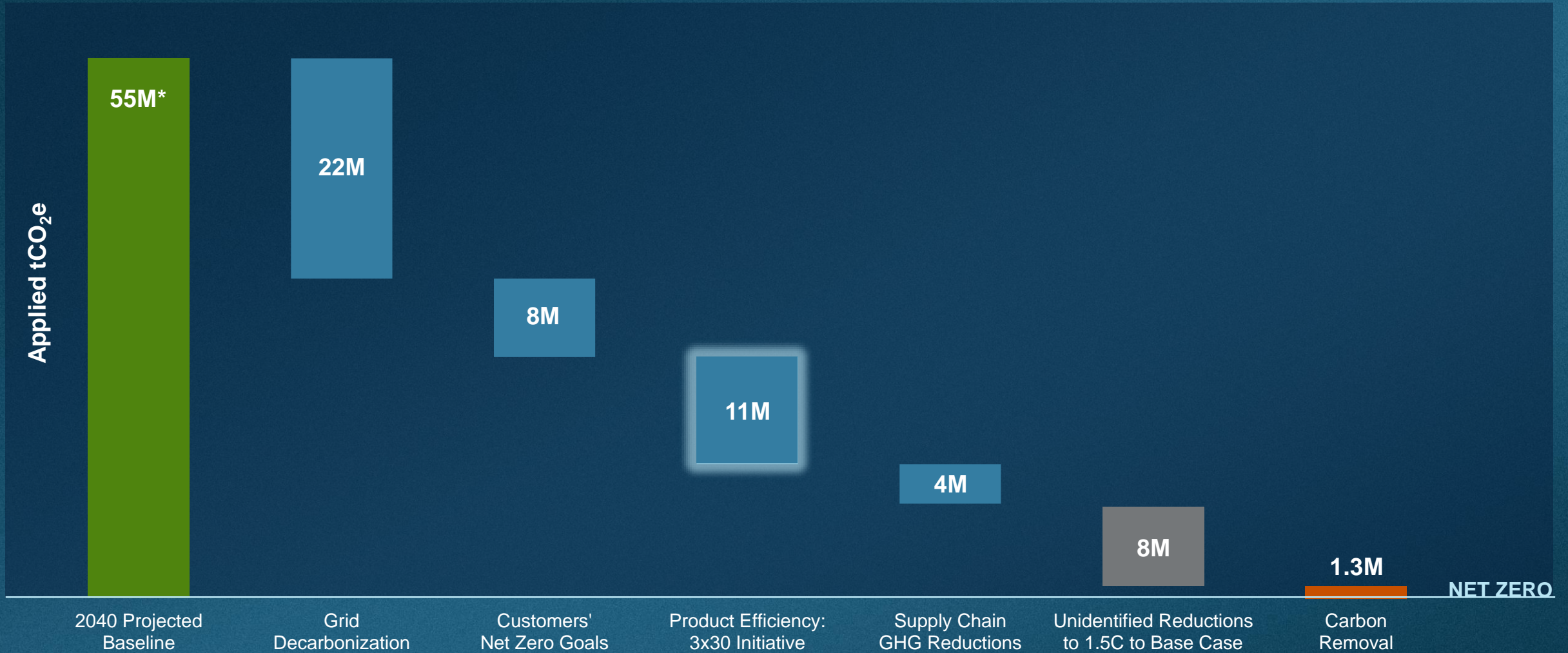
Drive to 100% of companies with Net Zero strategies

Support companies with existing plans to achieve their goals

Share Net Zero playbooks and BKMs



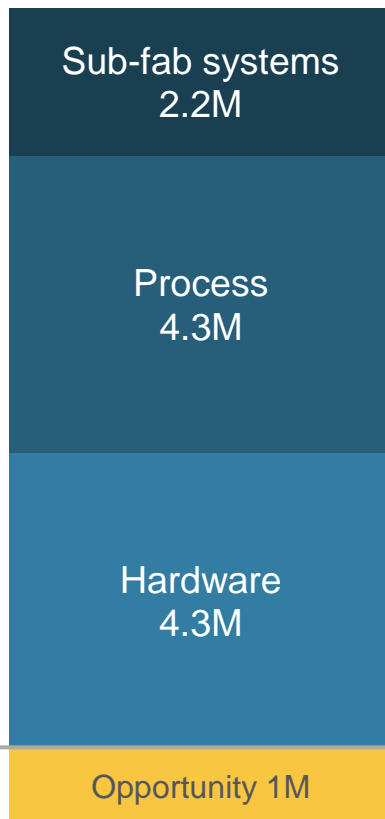
Applied's Net Zero Playbook – Base Case



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Improving Product Efficiency

11M tCO₂e by Strategy*
(accelerated adoption >12M tCO₂e)



* Current model based on available data in 2023.

Dedicated engineering team for sustainability (equipment, sub-fab, process recipes and operations)

3x30 initiative launched in 2020:
30% reduction in energy, chemical impact and cleanroom footprint by 2030

24 products and services in ecoUP portfolio

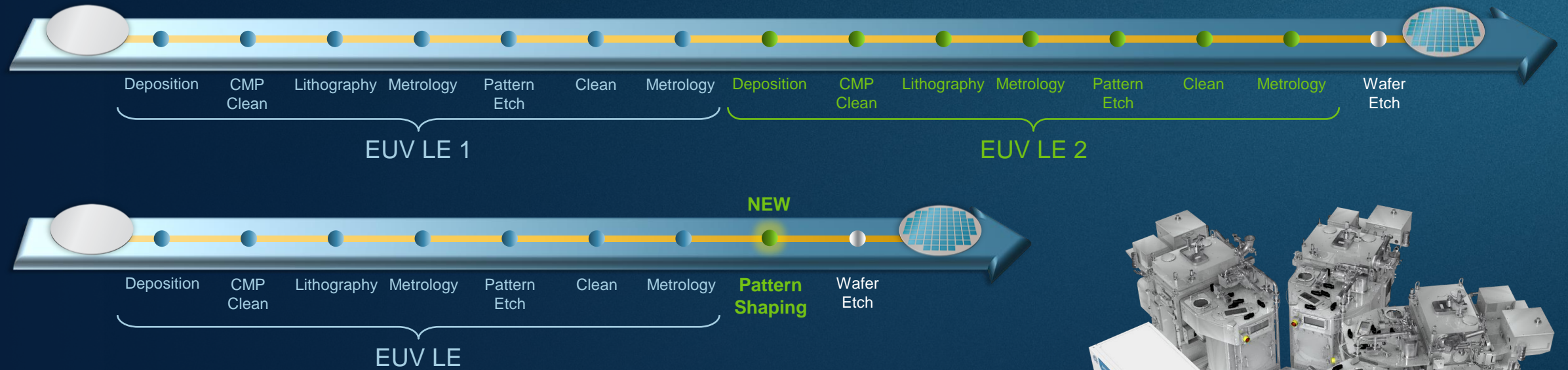
CALL TO ACTION:

Accelerate adoption of ecoUp solutions

3 X 30 **ecoUP**TM

Case Study – Sculpta[®] Pattern Shaping

SIMPLIFIED PROCESS FLOWS



- » Eliminates alignment errors
- » Lowers capital costs
- » Provides energy and materials savings

PER LAYER:

- >15kWh per wafer
- >0.35kg CO₂e per wafer
- ~15L of water per wafer



EcoTwin[®]

Eco-Efficiency Software

COMPARE resource consumption of different recipes to **OPTIMIZE** carbon footprint

MONITOR energy and gases in real-time to assess environmental impact of chambers, platform and sub-fab components

REPORT continuous improvements in environmental performance

Endura®

IMS workhorse
for small
chambers

Centura®

Large-chamber
compatibility

Producer®

High throughput
density for small
chambers

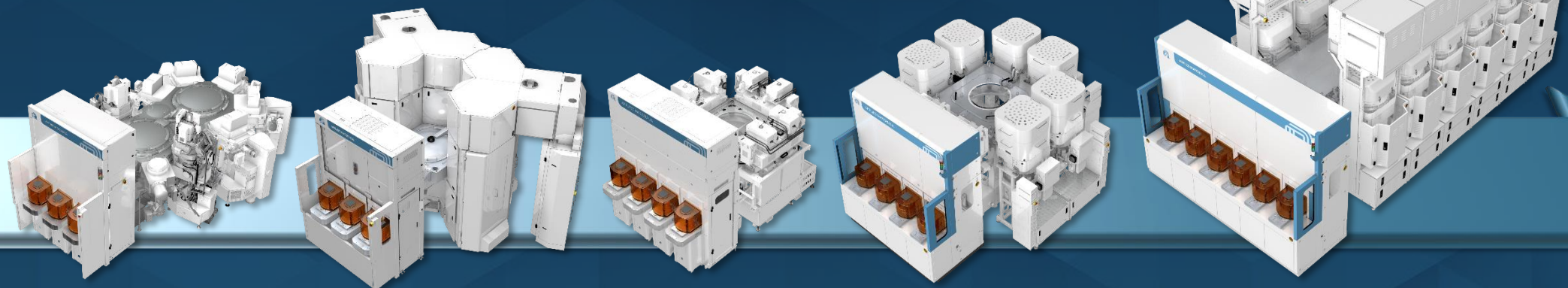
Centris®

High throughput
density for large
chambers

INTRODUCING

Vistara™

High throughput
density for large
chambers

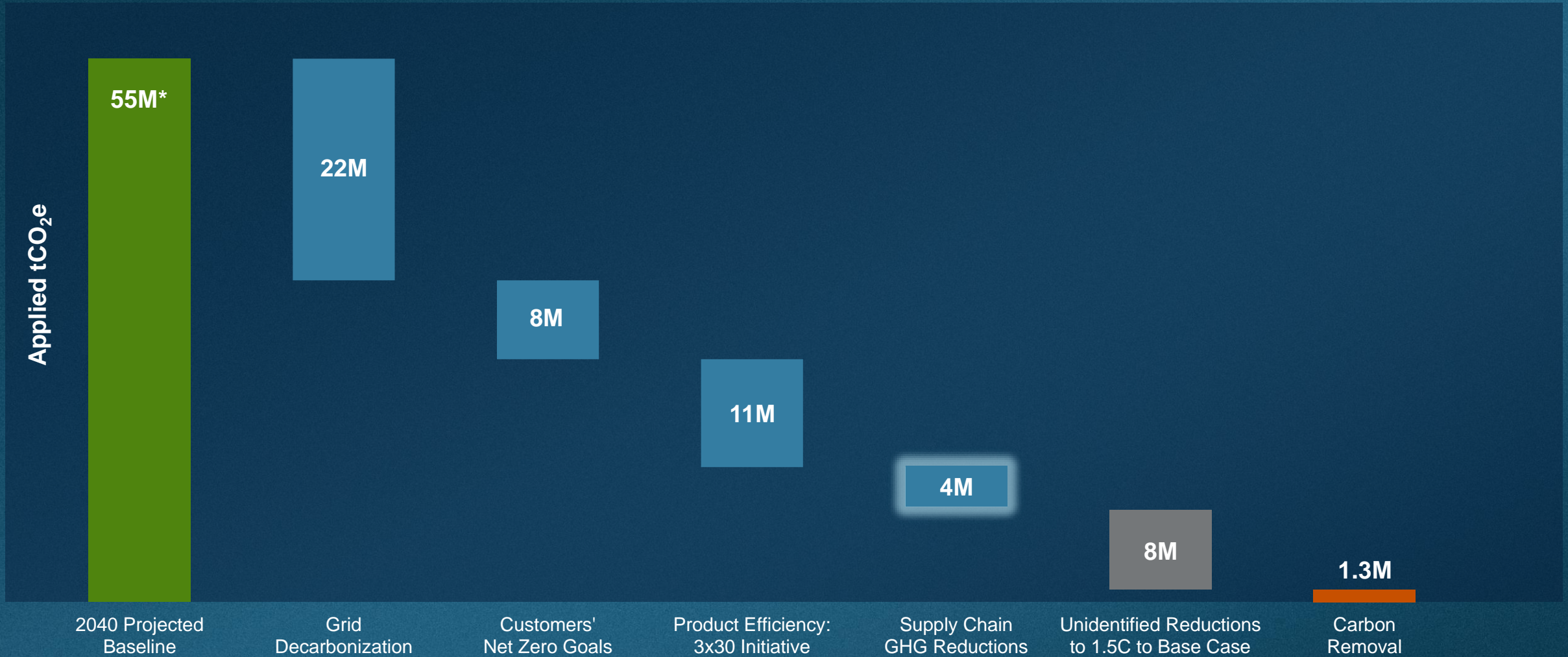


Applied's first purpose-built **low-carbon platform**

~35% reduction in platform energy consumption

~30% reduction in cleanroom footprint

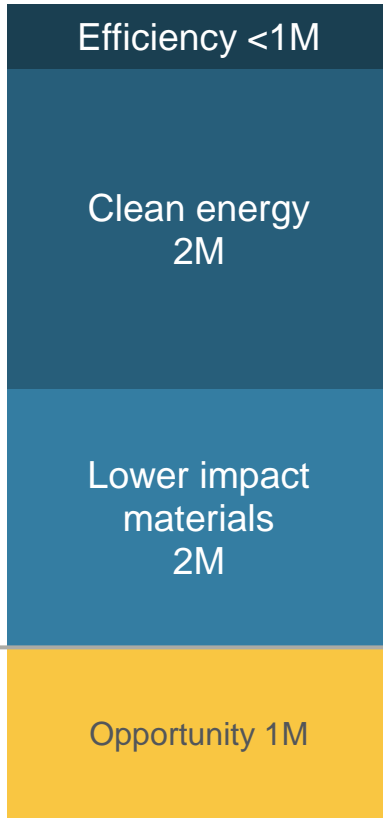
Applied's Net Zero Playbook – Base Case



*Covers 90% of Applied's Scope 3 per SBTi (87% product use emissions; 13% supply chain). GHG = Greenhouse Gas

Transforming Applied's Supply Chain

>4M tCO₂e by Strategy*
(accelerated adoption >5M tCO₂e)



*indicative based on available data; further analysis required

SuCESS 2030 initiative launched in 2020

Working with >100 suppliers on greenhouse gas emissions data collection + reduction programs in place with top suppliers

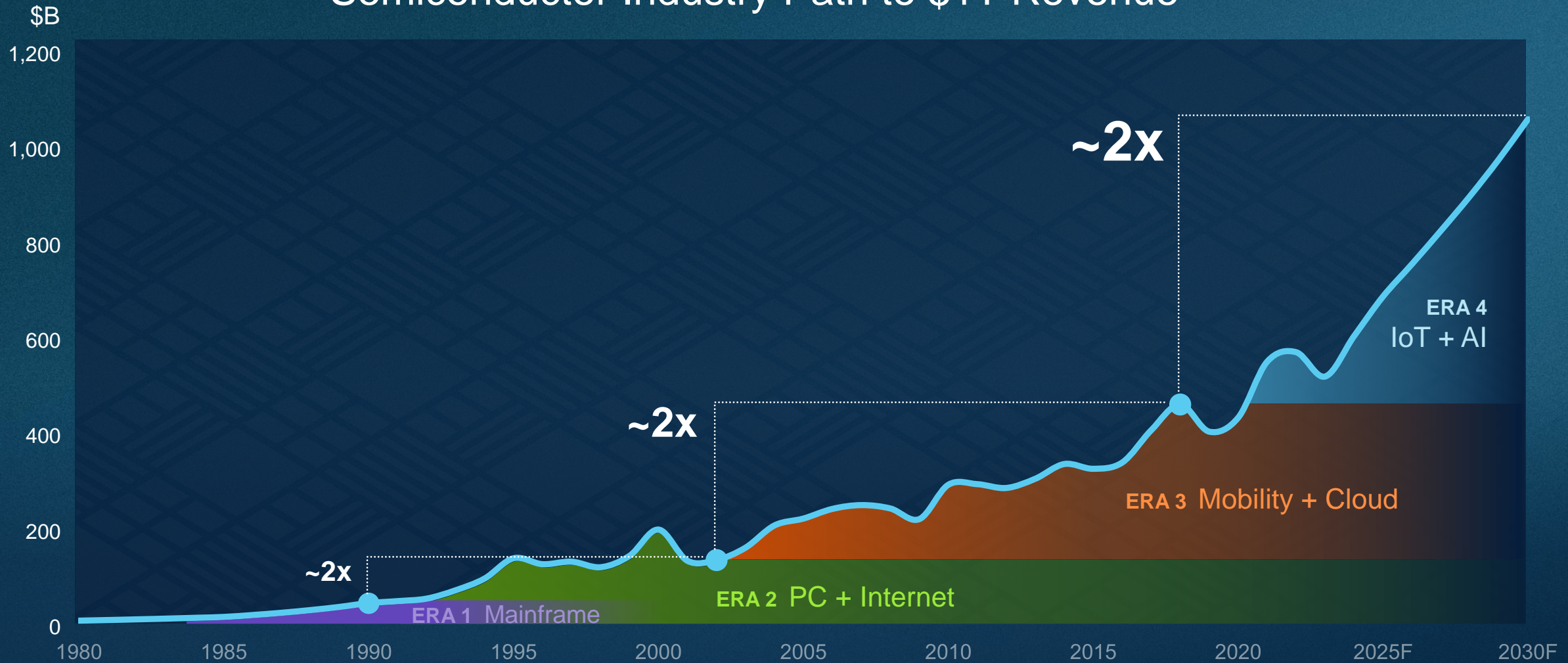
Increased spend with diverse suppliers by \$0.5B in past two years

Launching new supply chain energy partnership program

SUCCESS
2030

Schneider
Electric

Semiconductor Industry Path to \$1T Revenue

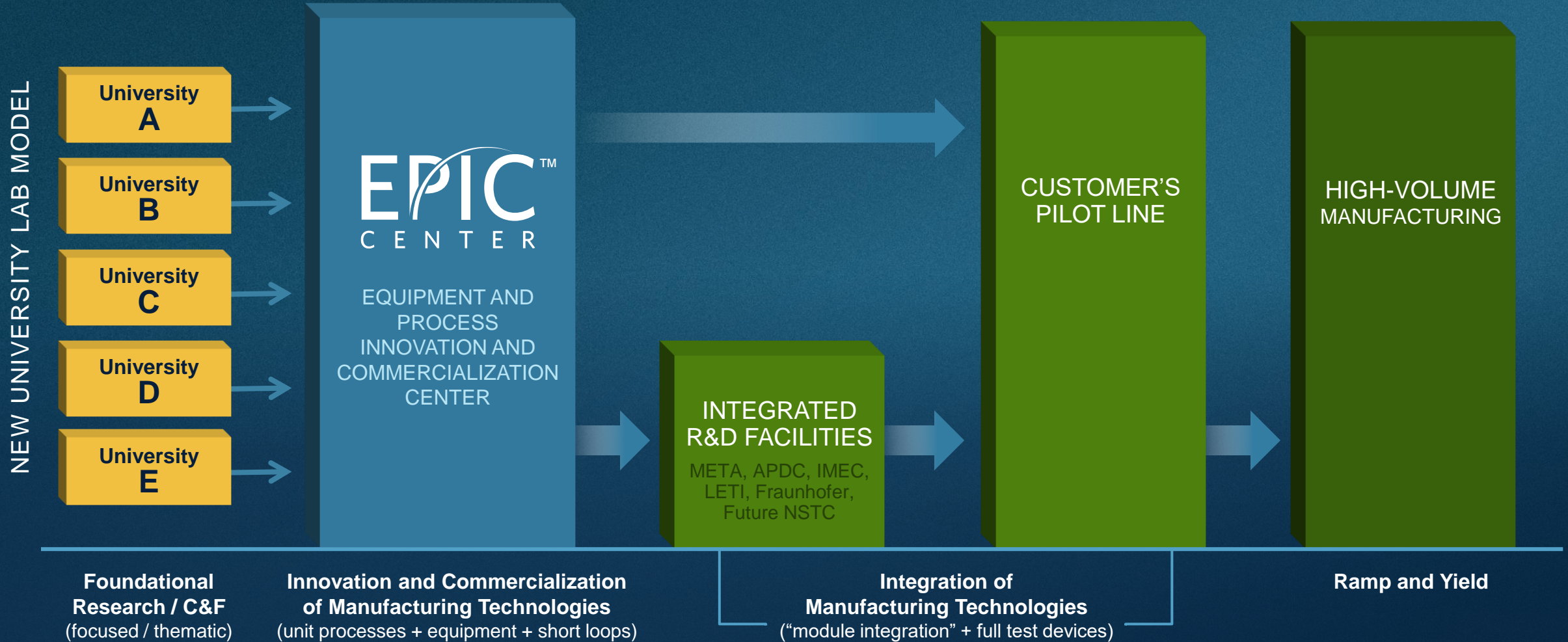


Each computing era ~doubles size of semiconductor market and accelerates the need for energy efficient computing

Source: SIA, Applied Materials - SMI

Applied Materials External Use

Innovating The Way We Innovate...



MAKE POSSIBLE
a better
FUTURE

Accelerate the energy-
efficient computing
roadmap (10,000x)

AND

Deliver Net Zero
semiconductor
manufacturing (1x, 100x)



APPLIED
MATERIALS®

make possible